

SALES ASSEMBLY DRAWINGS FOR SMALL FORM-FACTOR AND Z AXIS PLUGGABLE CONNECTORS

CKT SIZE	PART NUMBER	TOOLED	DESCRIPTION	"A"	"B"	"C"	"D"	MULTI-SOURCE AGREEMENT	CONNECTOR DRAWING	CIRCUIT BOARD DRAWING
20	74441-0001	YES	PLATED PER NOTE 2	1.10/.043	11.00/.433	9.40/.370	9.60/.378	SFP	PAGE 2	PAGE 3
	74441-0004	NO*	PLATED PER NOTE 2	0.76/.030						
	74441-0010	YES	PLATED PER NOTE 3	1.10/.043						
	74441-0014	NO*	PLATED PER NOTE 3	0.76/.030						
	74441-0021	YES	PLATED PER NOTE 4	1.10/.043						
	74441-0031	YES	PLATED PER NOTE 5	1.10/.043						
30	74441-0041	YES	PLATED PER NOTE 6	1.10/.043						
	74441-0007	YES	PLATED PER NOTE 2	1.10/.043	15.00/.591	13.40/.528	13.60/.535	XFP	PAGE 2	PAGE 4
	74441-0017	YES	PLATED PER NOTE 3	1.10/.043						
40	74441-0027	YES	PLATED PER NOTE 4	1.10/.043						
	74441-0005	YES	PLATED PER NOTE 2	1.10/.043	19.00/.748	17.40/.685	17.60/.693		PAGE 2	PAGE 5
	74441-0015	YES	PLATED PER NOTE 3	1.10/.043						
50	74441-0025	YES	PLATED PER NOTE 4	1.10/.043						
	74441-0008	YES	PLATED PER NOTE 2	1.10/.043	23.00/.906	21.40/.843	21.60/.850		PAGE 2	PAGE 6
	74441-0018	YES	PLATED PER NOTE 3	1.10/.043						
	74441-0028	YES	PLATED PER NOTE 4	1.10/.043						
70	74441-0038	YES	PLATED PER NOTE 5	1.10/.043						
	74441-0003	YES	PLATED PER NOTE 2	1.10/.043	31.00/1.220	29.40/1.157	29.60/1.165	XENPAK XPAK X2	PAGE 2	PAGE 7
	74441-0013	YES	PLATED PER NOTE 3	1.10/.043						
	74441-0023	YES	PLATED PER NOTE 4	1.10/.043						
	74441-0033	YES	PLATED PER NOTE 5	1.10/.043						

NOTES

1. MATERIAL:

HOUSING - HIGH TEMPERATURE THERMOPLASTIC GLASS FILLED, UL 94V-0, BLACK
TERMINALS - COPPER ALLOY

2. PLATING:

CONTACT AREA - 0.38 μ m MIN GOLD OVER 2.54 μ m MIN NICKEL
SOLDER FOOT AREA - 2.54 - 5.09 μ m TIN OVER 2.54 μ m MIN NICKEL.

3. PLATING:

CONTACT AREA - 0.76 μ m MIN GOLD OVER 2.54 μ m NICKEL
SOLDER AREA - 2.54 -5.09 μ m TIN OVER 2.54 μ m MIN NICKEL

4. PLATING:

CONTACT AREA - 0.76 μ m MIN GOLD OVER 2.54 μ m NICKEL; LUBRICATED
SOLDER AREA: GOLD FLASH OVER 2.54 μ m MIN NICKEL.

5. PLATING:

CONTACT AREA - 0.76 μ m MIN GOLD OVER 2.54 μ m NICKEL,
SOLDER AREA: GOLD FLASH OVER 2.54 μ m MIN NICKEL.

6. PLATING:

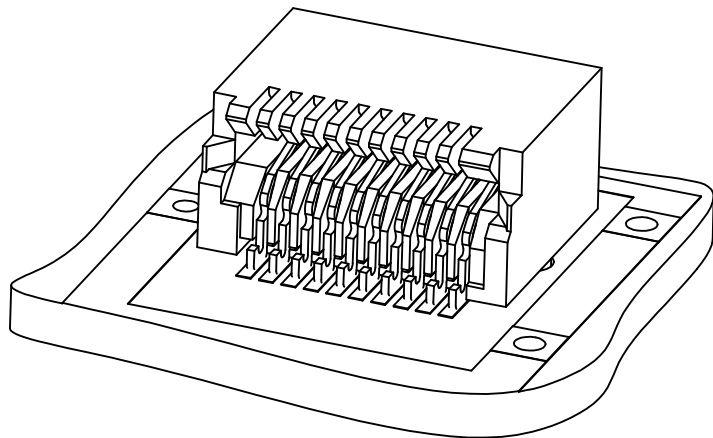
CONTACT AREA - 0.38 μ m MIN GOLD OVER 2.54 μ m NICKEL,
SOLDER AREA: GOLD FLASH OVER 2.54 μ m MIN NICKEL.

7. TERMINAL SOLDER FEET TO BE COPLANAR WITHIN 0.10/.004 FOR 20, 30 AND 40 CIRCUIT CONNECTORS
TERMINAL SOLDER FEET TO BE COPLANAR WITHIN 0.15/.006 FOR 70 CIRCUIT CONNECTOR

8. * CONTACT PLANT FOR MORE INFORMATION

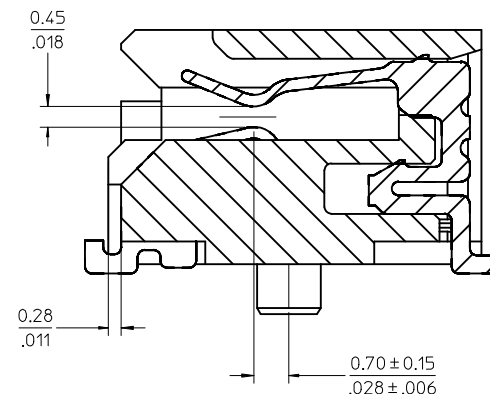
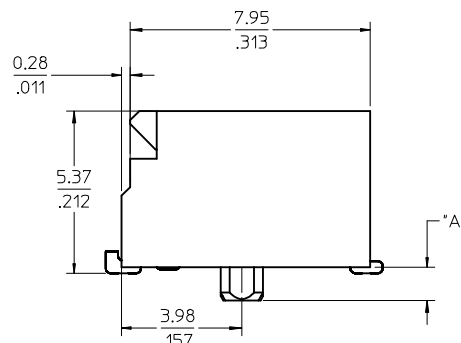
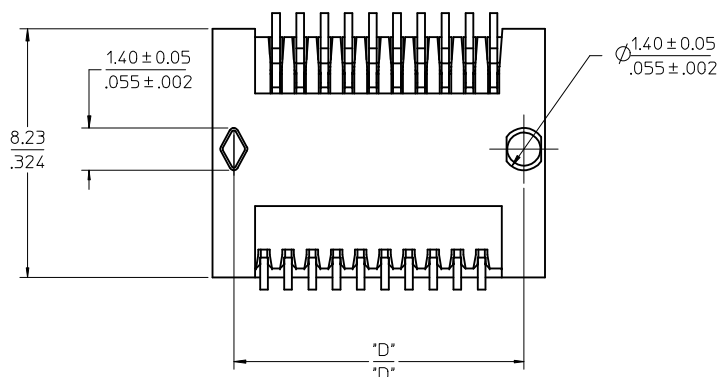
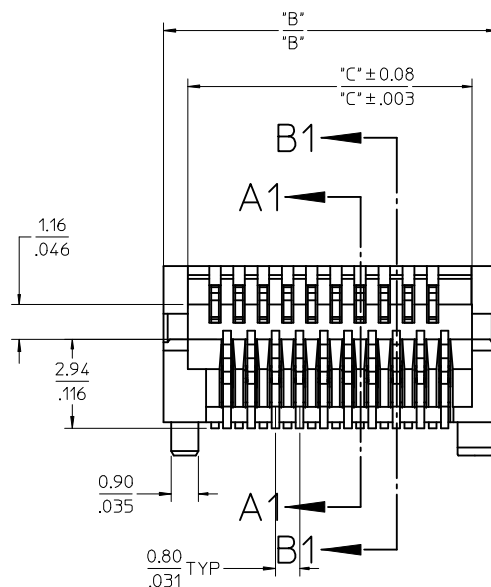
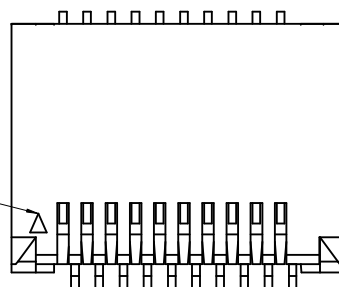
9. DATE CODE: 4 DIGIT (3 DIGIT DATE, 1 DIGIT YEAR)

10. CIRCUIT 1 IDENTIFIER LOCATED ON ALL PART NUMBERS

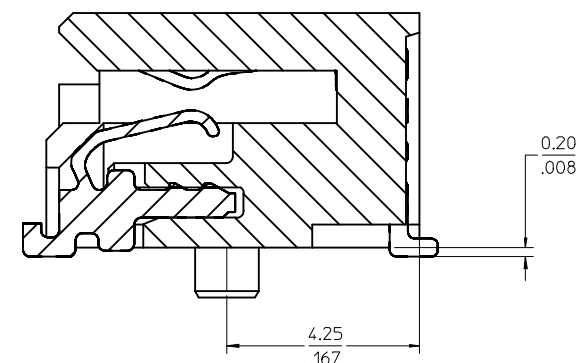


ADD -0041 EC NO: UCP2009-1455 DRAWN BY: DRWN:MS BARRA CHKD:BSMART APPR:SMILLER REV T	DESCRIPTION 2009/01/15 2009/01/15 2009/01/16	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM/IN		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
			4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± 0.13 ± .005 1 PLACE ± 0.25 ± .010 ANGULAR ± 1/2°	mm INCH	DRAWN BY DATE 00/04/06 HIVERY CHECKED BY DATE 00/04/06 KSWEENEY APPROVED BY DATE 00/04/06 MBANAKIS	TITLE SALES ASSEMBLY Z AXIS PLUGGABLE PCB CONNECTOR	DOCUMENT NO. SD-74441-001	SHEET NO. 1 OF 7		
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			

CIRCUIT 1
IDENTIFIER



SECTION A1-A1
SCALE 12:1



SECTION B1-B1
SCALE 12:1

SEE SHEET 1
EC NO: UCP2009-1455
DRAWN BY: DRWN:SBARRA 2009/01/15
CHKD:BSMART 2009/01/15
APPR:SMILLER 2009/01/16

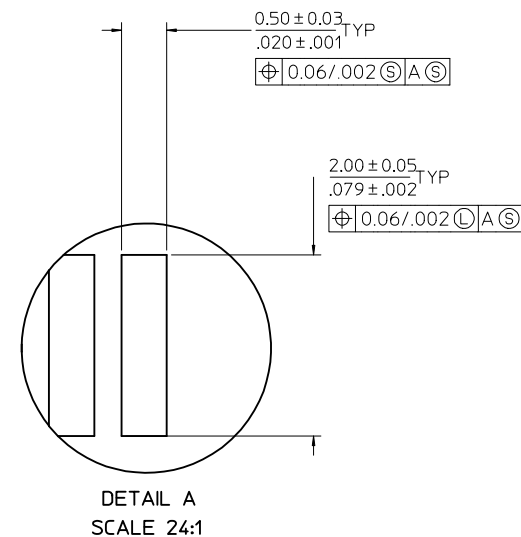
REVISION
DESCRIPTION
REV. 1

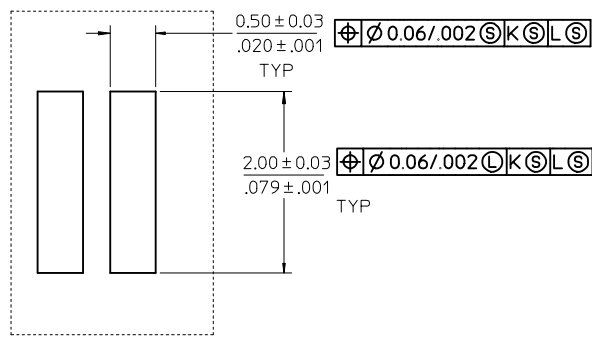
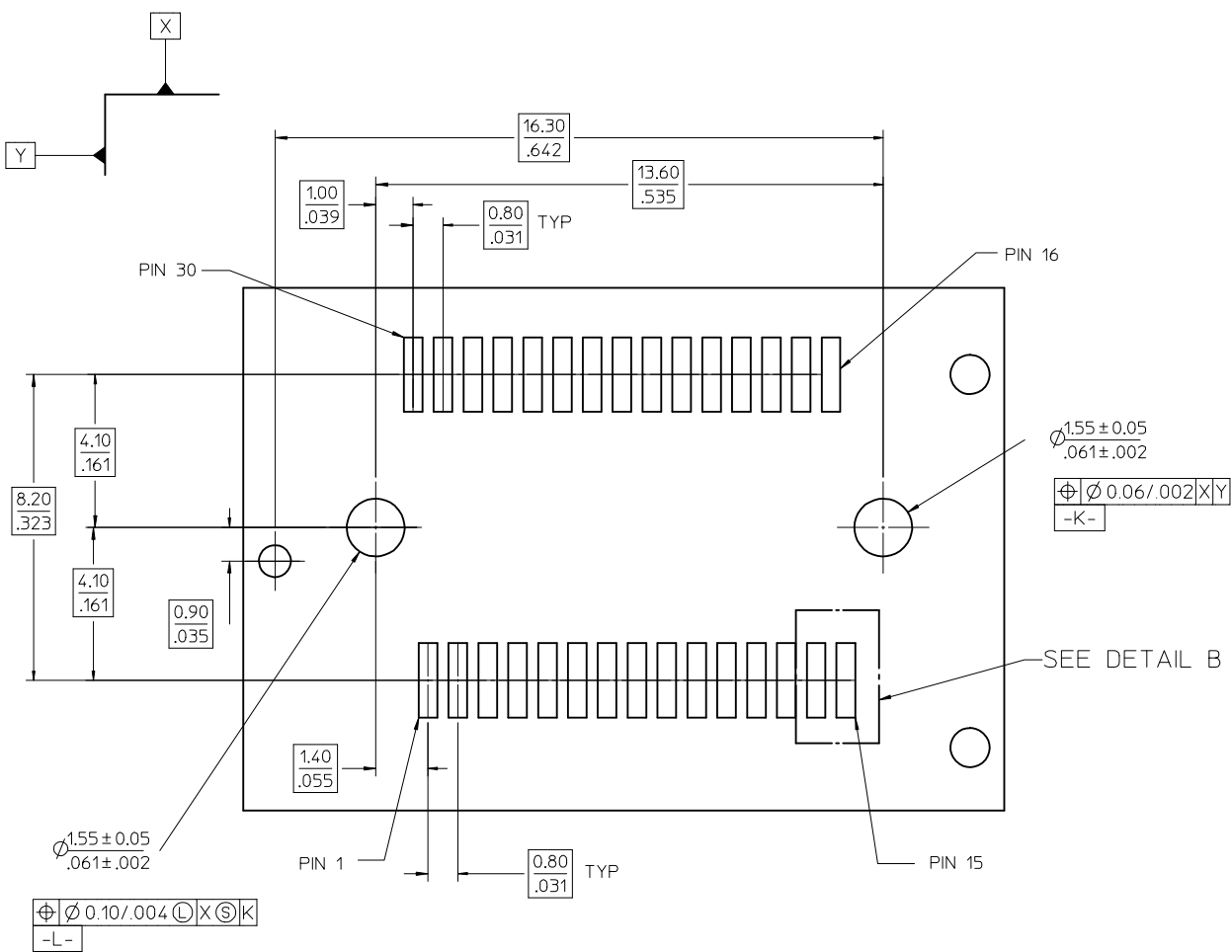
QUALITY SYMBOLS
=0
=0

GENERAL TOLERANCES (UNLESS SPECIFIED)
mm INCH
4 PLACES ± --- ± ---
3 PLACES ± --- ± ---
2 PLACES ± 0.13 ± .005
1 PLACE ± 0.25 ± .010
ANGULAR ± 1/2°
DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
MM/IN
DRAWN BY: HAVERY
DATE: 00/04/06
CHECKED BY: KSWEENEY
DATE: 00/04/06
APPROVED BY: MBANAKIS
DATE: 00/04/06
MATERIAL NO.
SIZE: C
SEE TABLE

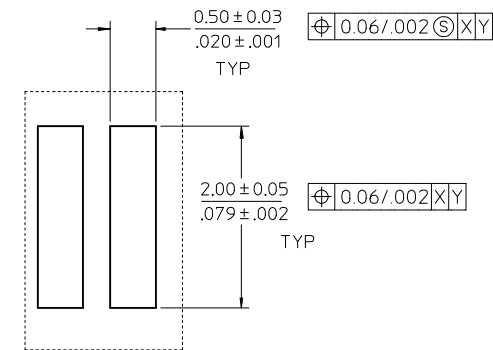
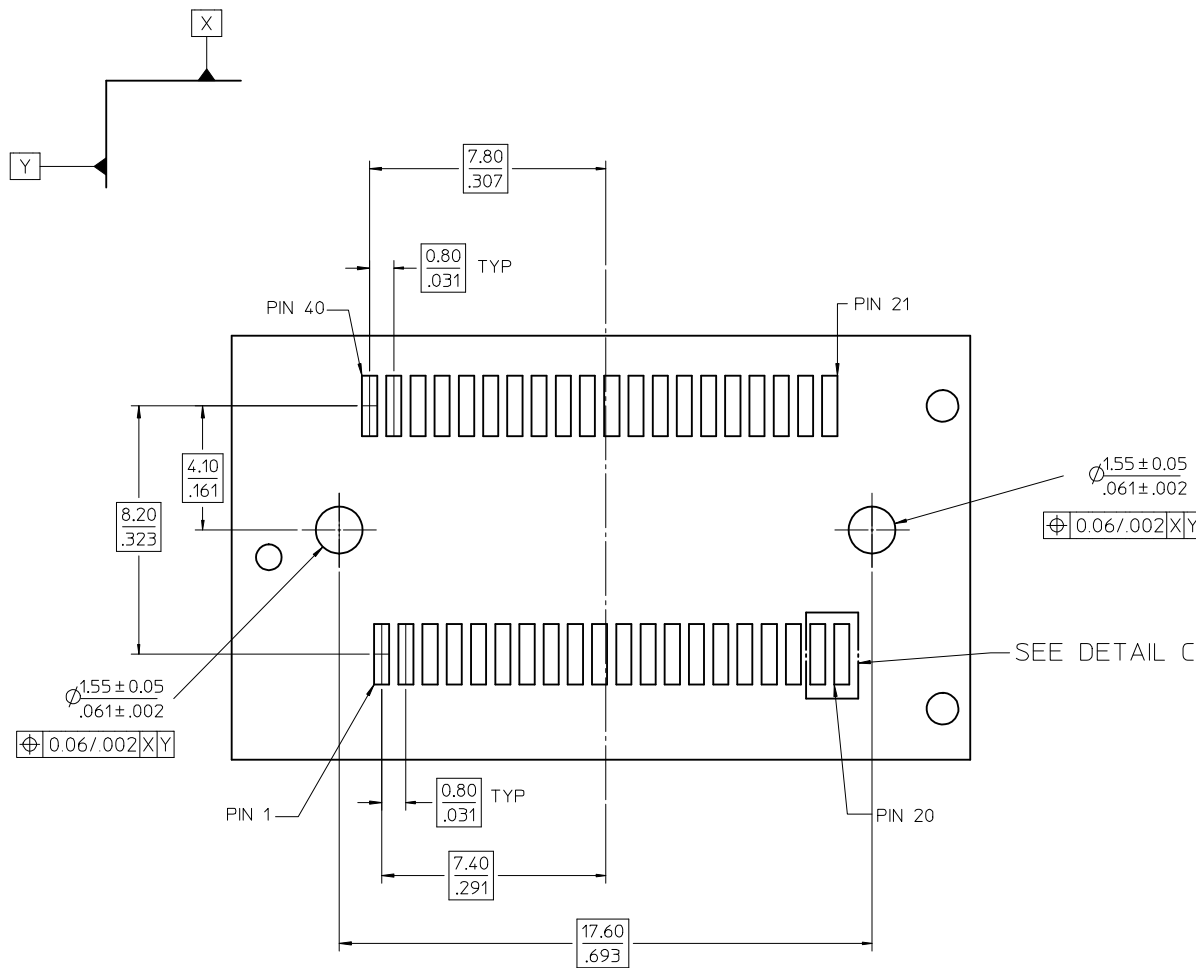
SCALE: 6:1
DESIGN UNITS: METRIC
THIRD ANGLE PROJECTION
SALES ASSEMBLY
Z AXIS PLUGGABLE
PCB CONNECTOR
MOLEX INCORPORATED
DOCUMENT NO. SD-74441-001
SHEET NO. 2 OF 7
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION





30 CIRCUIT MOTHER BOARD
RECOMMENDED PCB LAYOUT

SEE SHEET 1 EC NO: UCP2009-1455 T DRWN:MSIBARRA 2009/01/15 CHKD:BSMART 2009/01/15 APPR:SMILLER 2009/01/16	REV	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM/IN		SCALE 6:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION				
						DRAWN BY HAVERY	DATE 00/04/06	TITLE SALES ASSEMBLY Z AXIS PLUGGABLE PCB CONNECTOR						
						CHECKED BY KSWEENEY	DATE 00/04/06							
						APPROVED BY MBANAKIS	DATE 00/04/06				 MOLEX INCORPORATED			
				ANGULAR ±1/2°		MATERIAL NO.		DOCUMENT NO.						SHEET NO.
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-74441-001						4 OF 7
						SIZE C	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							



DETAIL C
SCALE 24:1

40 CIRCUIT MOTHER BOARD RECOMMENDED PCB LAYOUT

SEE SHEET 1	EC NO: UCP2009-1455			DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE		SCALE	DESIGN UNITS	 THIRD ANGLE PROJECTION	
	DRWN:MSIBARRA 2009/01/15								MM/IN		6:1	METRIC		
	CHKD:BSMART 2009/01/15								DRAWN BY	DATE	TITLE			
	APPR:SMILLER 2009/01/16								HAVERY	00/04/06	SALES ASSEMBLY			
									CHECKED BY	DATE	Z AXIS PLUGGABLE			
									KSWEENEY	00/04/06	PCB CONNECTOR			
									APPROVED BY	DATE	MOLEX MOLEX INCORPORATED			
									MBANAKIS	00/04/06	SD-74441-001			
									MATERIAL NO.	DOCUMENT NO.		SHEET NO.		
									SEE TABLE					5 OF 7
						THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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